

1771127

https://www.phoenixcontact.com/us/products/1771127

Please be informed that the data shown in this PDF document is generated from our online catalog. Please find the complete data in the user documentation. Our general terms of use for downloads are valid.



PCB terminal block, nominal current: 6 A, rated voltage (III/2): 160 V, nominal cross section: 0.5 mm², number of potentials: 5, number of rows: 1, number of positions per row: 5, product range: PTSM 0,5/..-V-SMD, pitch: 2.5 mm, connection method: Push-in spring connection, mounting: SMD soldering, conductor/PCB connection direction: 90 °, color: black, Pin layout: Linear pad geometry, number of solder pins per potential: 1, type of packaging: 44 mm wide tape

Your advantages

- · Time saving push-in connection, tools not required
- · Defined contact force ensures that contact remains stable over the long term
- · High current carrying capacity of 6 A in very compact dimensions
- · Designed for integration into the SMT soldering process
- · Vertical connection enables multi-row arrangement on the PCB
- Additional solder anchors reduce the mechanical strain on the soldering spots

Commercial data

| Item number | 1771127 |
|--------------------------------------|--------------------|
| Packing unit | 400 pc |
| Minimum order quantity | 400 pc |
| Sales key | AA11 |
| Product key | AAKDAC |
| Catalog page | Page 53 (C-1-2013) |
| GTIN | 4046356460156 |
| Weight per piece (including packing) | 2.64 g |
| Weight per piece (excluding packing) | 2.6 g |
| Customs tariff number | 85369010 |
| Country of origin | IN |



https://www.phoenixcontact.com/us/products/1771127

Technical data

Product properties

| Product line | COMBICON Terminals XS |
|---------------------------|--------------------------------|
| Product type | Printed circuit board terminal |
| Product family | PTSM 0,5/V-SMD |
| Number of positions | 5 |
| Pitch | 2.5 mm |
| Number of connections | 5 |
| Number of rows | 1 |
| Number of potentials | 5 |
| Pin layout | Linear pad geometry |
| Solder pins per potential | 1 |

Electrical properties

| Nominal current I _N | 6 A |
|--------------------------------|--------|
| Nominal voltage U _N | 160 V |
| Degree of pollution | 3 |
| Rated voltage (III/3) | 32 V |
| Rated surge voltage (III/3) | 2.5 kV |
| Rated voltage (III/2) | 160 V |
| Rated surge voltage (III/2) | 2.5 kV |
| Rated voltage (II/2) | 160 V |
| Rated surge voltage (II/2) | 2.5 kV |

Connection data

| Nominal cross section | 0.5 mm² |
|---|--|
| nductor connection | |
| Connection method | Push-in spring connection |
| Conductor cross section rigid | 0.14 mm ² 0.5 mm ² |
| Conductor cross section flexible | 0.2 mm ² 0.5 mm ² (up to 0.75 mm ² supported, with a stripping length of 7.5 mm and a rated insulation voltage of 32 V at III/2) |
| Conductor cross section AWG | 26 20 |
| Conductor cross section flexible, with ferrule without plastic sleeve | 0.25 mm² 0.5 mm² |
| Conductor cross section, flexible, with ferrule, with plastic sleeve | 0.25 mm ² 0.34 mm ² (possible from 0.14 mm ² , when using ferrule AI 0.14- 6 GY in combination with crimping pliers CRIMPFOX 10T-F) |
| Cylindrical gauge a x b / diameter | - / 1.2 mm |
| Stripping length | 6 mm |

Mounting

| Mounting type | SMD soldering |
|---------------|---------------|
|---------------|---------------|

PHŒN

X



1771127

https://www.phoenixcontact.com/us/products/1771127

| Pin layout | Linear pad geometry |
|--|---|
| Processing notes | |
| Process | Reflow soldering |
| Moisture Sensitive Level | MSL 1 |
| Classification temperature T_c | 260 °C |
| Solder cycles in the reflow | 3 |
| Material specifications | |
| Material data - contact | |
| Note | WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201 |
| Contact material | Cu alloy |
| Surface characteristics | hot-dip tin-plated |
| Metal surface terminal point (top layer) | Tin (4 - 8 μm Sn) |
| Metal surface soldering area (top layer) | Tin (4 - 8 μm Sn) |
| Material data - housing | |
| Color (Housing) | black (9005) |
| Insulating material | LCP |
| Insulating material group | Illa |
| CTI according to IEC 60112 | 175 |
| Flammability rating according to UL 94 | VO |
| Material data – actuating element | |
| Color (Actuating element) | black (9005) |
| Notes | |
| Note on application | Pick and place pads may protrude beyond the components. The PCB layout must ensure that collisions are avoided when components are assembled. |
| Dimensions | |
| Dimensional drawing | st life |



| Pitch | 2.5 mm |
|------------------|---------|
| Width [w] | 17.6 mm |
| Height [h] | 9 mm |
| Length [I] | 7 mm |
| Installed height | 9 mm |
| | |

PCB design

| Pad geometry | 1.4 x 3.4 mm |
|--------------|--------------|
| 0 , | |



1771127

https://www.phoenixcontact.com/us/products/1771127

Rated insulation voltage (III/3) Rated surge voltage (III/3)

minimum creepage distance (III/3)

minimum creepage distance (III/2)

Rated insulation voltage (II/2)

Rated insulation voltage (III/2) Rated surge voltage (III/2)

minimum clearance value - non-homogenous field (III/3)

minimum clearance value - non-homogenous field (III/2)

Mechanical tests

| Creation | |
|--|--|
| Specification | IEC 60998-2-2:2002-12 |
| Result | Test passed |
| Test for conductor damage and slackening | |
| Specification | IEC 60998-2-2:2002-12 |
| Result | Test passed |
| Pull-out test | |
| Specification | IEC 60998-2-2:2002-12 |
| Conductor cross section/conductor type/tractive force | 0.14 mm² / solid / > 10 N |
| setpoint/actual value | 0.2 mm² / flexible / > 10 N |
| | 0.5 mm² / solid / > 20 N |
| | 0.75 mm² / flexible / > 30 N |
| Flexion test | |
| Specification | IEC 60998-2-2:2002-12 |
| Result | Test passed |
| | |
| Insulation holder for crimp connections | |
| Result | Test passed |
| · . | Test passed |
| Result ectrical tests | Test passed IEC 60998-2-1:2002-12 |
| Result ectrical tests Temperature-rise test | |
| Result ectrical tests Temperature-rise test Specification | IEC 60998-2-1:2002-12 |
| Result ectrical tests Temperature-rise test Specification Requirement temperature-rise test | IEC 60998-2-1:2002-12 |
| Result ectrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance | IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K |
| Result ectrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification | IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 |
| Result ectrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions | IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 |
| Result ectrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances | IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ |

32 V

2.5 kV

1.5 mm

1.3 mm 160 V

2.5 kV

1.5 mm

1.6 mm

160 V



1771127

https://www.phoenixcontact.com/us/products/1771127

| Rated surge voltage (II/2) | 2.5 kV |
|---|--------|
| minimum clearance value - non-homogenous field (II/2) | 1.5 mm |
| minimum creepage distance (II/2) | 1.6 mm |

Environmental and real-life conditions

| Vibration test | |
|------------------------|-------------------------|
| Specification | IEC 60068-2-6:2007-12 |
| Frequency | 10 - 150 - 10 Hz |
| Sweep speed | 1 octave/min |
| Amplitude | 0.35 mm (10 Hz 60.1 Hz) |
| Sweep speed | 5g (60.1 Hz 150 Hz) |
| Test duration per axis | 2.5 h |
| Glow-wire test | |
| Specification | IEC 60998-1:2002-12 |

| Specification | IEC 60998-1:2002-12 |
|------------------|---------------------|
| Temperature | 850 °C |
| Time of exposure | 5 s |

Ambient conditions

| Ambient temperature (operation) | -40 °C 100 °C (Depending on the current carrying capacity/derating curve) |
|---|---|
| Ambient temperature (storage/transport) | -40 °C 70 °C |
| Relative humidity (storage/transport) | 30 % 70 % |
| Ambient temperature (assembly) | -5 °C 100 °C |

Packaging specifications Dimensional drawing

| 44 mm wide tape |
|--|
| 44 mm |
| 50.4 mm |
| 330 mm |
| Transparent-Bag |
| (D) electrostatically conductive |
| DIN EN 61340-5-1 (VDE 0300-5-1): 2008-07 |
| |



1771127

https://www.phoenixcontact.com/us/products/1771127

Classifications

ECLASS

| ECLASS-12.0 27460101 ECLASS-13.0 27460101 | ECLASS-11.0 | 27460101 |
|---|-------------|----------|
| ECLASS-13.0 27460101 | ECLASS-12.0 | 27460101 |
| | ECLASS-13.0 | 27460101 |

ETIM

| | ETIM 9.0 | EC002643 | | |
|---|-------------|----------|--|--|
| U | UNSPSC | | | |
| | UNSPSC 21.0 | 39121400 | | |



1771127

https://www.phoenixcontact.com/us/products/1771127

PHŒNIX CONTACT

Environmental product compliance

| China RoHS | Environmentally friendly use period: unlimited = EFUP-e |
|------------|---|
| | No hazardous substances above threshold values |

Phoenix Contact 2024 © - all rights reserved https://www.phoenixcontact.com

Phoenix Contact USA 586 Fulling Mill Road Middletown, PA 17057, United States (+717) 944-1300 info@phoenixcon.com